

ADVANCED DATA ANALYTICS AND DEEP LEARNING ON APACHE SPARK WITH BIGDL

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Big Data Technology, Intel

Outline

BigDL

Apache Spark* + High Performance + Deep Learning

Speech recognition:

Deep Speech 2 on BigDL: ML Pipeline + BigDL

Object detection:

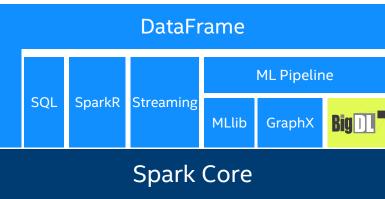
SSD and use cases.

BigDL

Bringing Deep Learning To Big Data Platform

- Distributed open source deep learning framework for Apache Spark*, 2000+ star on Github
- Make deep learning more accessible to big data users and data scientists
 - Write deep learning applications as standard Spark programs
 - Run on existing Spark/Hadoop clusters (no changes needed)
- Feature parity with popular deep learning frameworks
 - E.g., Caffe, Torch, Tensorflow, etc.
- High performance
 - Powered by Intel MKL and multi-threaded programming
- Efficient scale-out
 - Leveraging Spark for distributed training & inference





https://github.com/intel-analytics/BigDL https://bigdl-project.github.io/



BigDL Answering The Needs

Make deep learning more accessible to big data and data science communities

Continue the use of familiar SW tools and HW infrastructure to build deep learning applications

Add deep learning functionalities to the Big Data (Spark) programs and/or workflow

- Leverage existing Hadoop/Spark clusters to run deep learning applications
 - Shared with other workloads (e.g., ETL, data warehouse, feature engineering, statistic machine learning, graph analytics, etc.) in a dynamic and elastic fashion

Basic Component

Tensor:

- ND-array data structure
- Generic data type
- Rich and fast math operations (powered by Intel MKL)

Layers

150+ layers (Conv, 3D Conv, Pooling, RNN, FC ...)

Criterion

 20+ criterions (DiceCoefficient, ClassNLL, CrossEntropy ...)

Optimization

 SGD, Adagrad, LBFGS, Adam, Adadelta, RMSprop, Adamx



DEEP SPEECH 2 WITH BIGDL



Deep Speech 2 for Speech Recognition

DS2 system outperforms humans in 3 out of the 4 test sets and is competitive on the fourth.

Read Speech					
Test set	DS1	DS2	Human		
WSJ eval'92	4.94	3.60	5.03		
WSJ eval'93	6.94	4.98	8.08		
LibriSpeech test-clean	7.89	5.33	5.83		
LibriSpeech test-other	21.74	13.25	12.69		

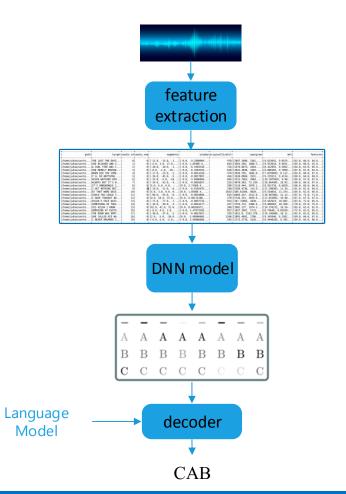
Table 13: Comparison of WER for two speech systems and human level performance on read speech.

Deep Speech 2 on BigDL

Deep Speech 2: End-to-End Speech Recognition in English and Mandarin

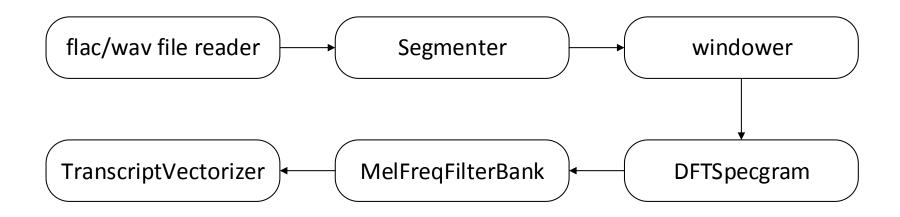
Baidu Research - Silicon Valley AI Lab*

Dario Amodei, Rishita Anubhai, Eric Battenberg, Carl Case, Jared Casper, Bryan Catanzaro, Jingdong Chen, Mike Chrzanowski, Adam Coates, Greg Diamos, Erich Elsen, Jesse Engel, Linxi Fan, Christopher Fougner, Tony Han, Awni Hannun, Billy Jun, Patrick LeGresley, Libby Lin, Sharan Narang, Andrew Ng, Sherjil Ozair, Ryan Prenger, Jonathan Raiman, Sanjeev Satheesh, David Seetapun, Shubho Sengupta, Yi Wang, Zhiqian Wang, Chong Wang, Bo Xiao, Dani Yogatama, Jun Zhan, Zhenyao Zhu



Deep Speech 2 on BigDL: Feature transformers

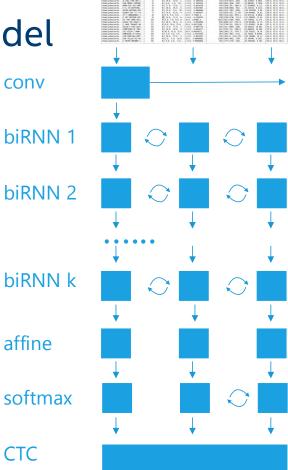
Apache Spark* ML Pipeline



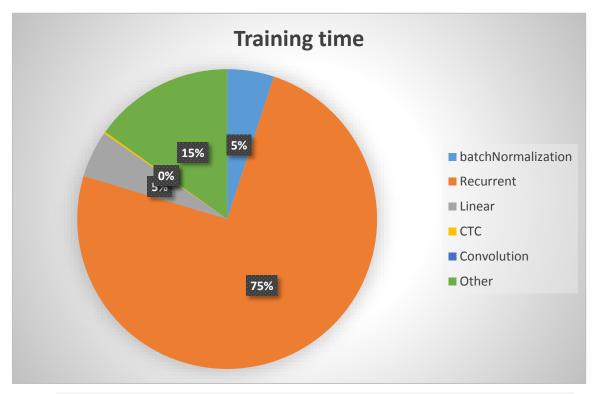
Deep Speech 2 on BigDL: Model

```
val model = Sequential[T]()
   .add(conv)
   .add(ReLU[T]())
   .add(Squeeze(4))
   .add(brnn)
   .add(linear1)
   .add(HardTanhDS[T](0, 20, true))
   .add(linear2)
```

9 layers biRNN: >50 Million parameters



Deep Speech 2 on BigDL: Model training



With libriSpeech, 5 RNN layer, 30 seconds uttLength, 30 epoches.

Deep Speech 2 with LibriSpeech

- Deep Speech 2 (12 layers, 9 RNN), uttLength 30 seconds, with arg-max decoder
 - Word Error Rate with hold-out validation dataset

	cer	wer(without LM)
Hannun, et al. (2014)	10.7	35.8
Graves-Jaitly (ICML 2014)	9.2	30.1
Hwang-Sung (ICML 2016)	10.6	38.4
BigDL	8.7	32.4

Deep Speech 2 on BigDL: Summary

Feature transformers:

 Flac/wav Reader, Windower, TimeSegmenter, TranscriptVectorizer, DFTSpecgram, MelFrequencyFilterBank

Model training and inference

Big DL container, optimizer, Convolution, BatchNormalization, Bi-RNN

CTC (Connectionist Temporal Classification) loss

Scala or JNI (warp-ctc)

Decoder

ArgmaxDecoder, VocabDecoder

Evaluation

wer, cer

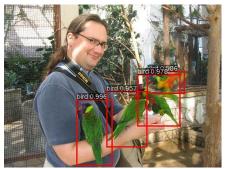
OBJECT DETECTION WITH BIGDL

SSD: Single Shot Multibox Detector

- State-of-the-art object detection pipeline
- Single shot

Liu, Wei, et al. "SSD: Single shot multibox detector." European Conference on Computer Vision. Springer International Publishing, 2016.

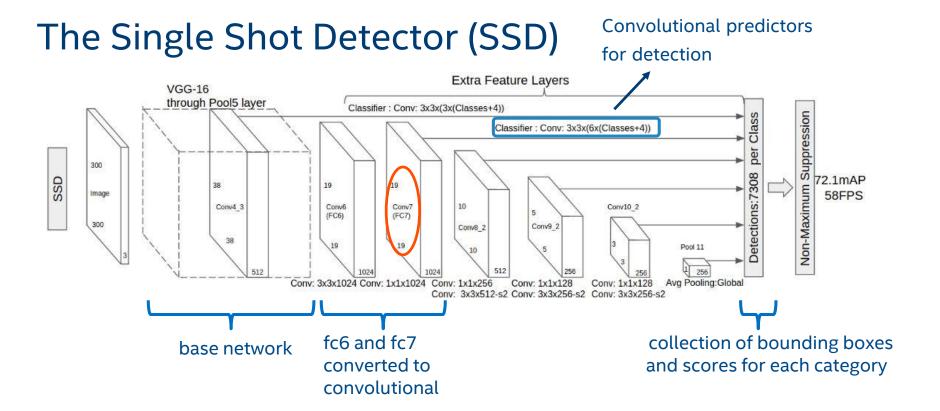








Images from PASCAL(http://host.robots.ox.ac.uk/pascal/VOC/)



Multi-scale feature maps for detection: observe how conv feature maps decrease in size and allow predictions at multiple scales



SSD Pipeline

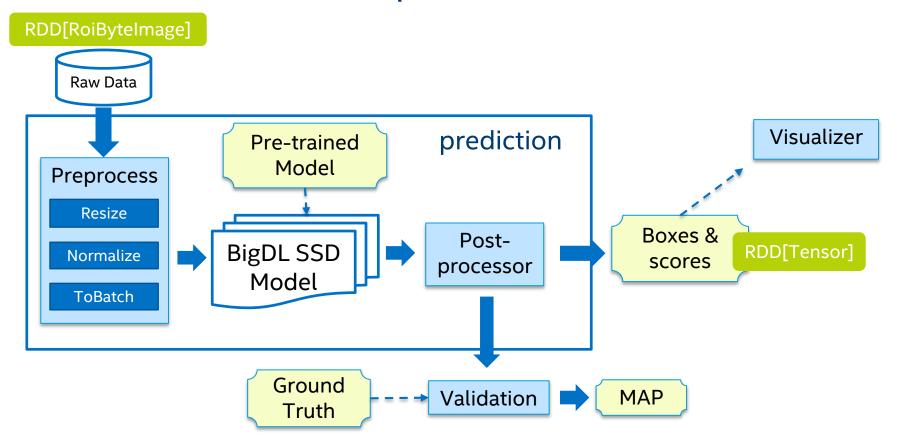


Image Pre-processing for Spark ML Pipeline

Image Transformer based on steps, use OpenCV.Mat as interchange format.

```
val steps = BytesToMat() ->
    Resize(250, 250) ->
    Flip(Flip.HORIZONTAL_FLIP) ->
    Cropper(224, 224) ->
    BGRImageNormalizer(0.485f, 0.456f, 0.406f, 0.229f, 0.224f, 0.225f) ->
    BGRToRGB() ->
    MatToFloats()

val imgTransfomer = new ImageTransformer(steps)
    .setInputCol("imagseData").setOutputCol("feature")
```





SSD + VGG test over Pascal VOC 2007

• SSD + VGG 300x300 with pretrained model over voc07+12

	Caffe Model	BigDL
Mean Average Precision	77.2	77.3

• SSD + VGG 512x512 with pretrained model over voc07+12

	Caffe Model	BigDL
Mean Average Precision	79.6	79.6

JD.com: Find visually similar products





(a) Similar catalog items with and without human model



(b) Concept based similarity across spooky printed t-shirts





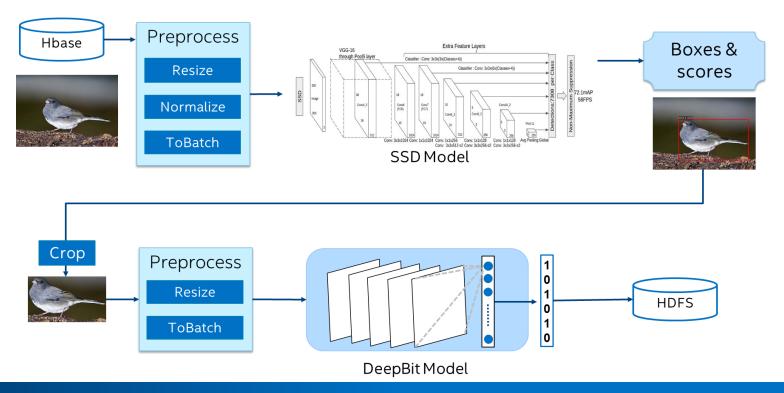
(c) Detail based similarity via spacing and thickness of stripes





(d) Wild Image similarity across radically different poses

JD.com: Image Detection & Extraction Pipeline (using SSD + DeepBit Models)



Similar house search





















Latency: 1000 image comparison 0.03 second on single thread





Challenges of Large-Scale Processing in GPU

Reading images out takes a very long time

Image pre-processing on HBase is very complex

No existing software frameworks can be leveraged

• E.g., resource management, distributed data processing, fault tolerance, etc.

Very challenging to scale out to massive amount of pictures

Due to SW and HW infrastructure constraints

Upgrading to BigDL Solutions

Reuse existing Hadoop/Spark clusters for deep learning with no changes

Efficiently scale out on Spark with superior performance

Reading HBase data no longer a bottleneck

Very easy to build the end-to-end pipeline in BigDL

- Image transformation and augmentation based on OpenCV on Spark val preProcessor = BytesToMat() -> Resize(300, 300) -> ... val transformed = preProcessor(dataRdd)
- Directly Load pre-trained models (BigDL/Caffe/Torch/TensorFLow) into BigDL val model = Module.loadCaffeModel(caffeDefPath, caffeModelPath)

Model Quantization for Efficient Inference in BigDL

Local quantization scheme converting floats to intergers

- Faster compute and smaller models
- Take advantage of SSE and AVX instructions on Xeon servers
- Supports pre-trained models (BigDL/Caffe/Torch/TensorFLow)

```
val model = Module.loadCaffeModel(caffeDefPath, caffeModelPath)
val quantizedModel = model.quantize()
```

Quantized SSD model

- ~4x model size reduction
- >2x inference speedup
- ~0.001 mAP (mean average precision) loss

Try BigDL Out

Running BigDL, Deep Learning for Apache Spark, on AWS*
(Amazon* Web Service)

https://aws.amazon.com/blogs/ai/runningbigdl-deep-learning-for-apache-spark-on-aws/ Use BigDL on Microsoft*
Azure* HDInsight*

https://azure.microsoft.com/enus/blog/use-bigdl-on-hdinsight-spark-fordistributed-deep-learning/ BigDL on Alibaba* Cloud E-MapReduce*

https://yq.aliyun.com/articles/73347

BigDL on CDH* and Cloudera*
Data Science Workbench*

http://blog.cloudera.com/blog/2017/04/bigdlon-cdh-and-cloudera-data-science-workbench/

Intel's BigDL on Databricks*

https://databricks.com/blog/2017/02/09/in tels-bigdl-databricks.html BigDL Distribution in Cray Urika-XC Analytics Suite

http://www.cray.com/products/analytics/uri ka-xc

PARTNER WITH US



- Use BigDL & Share your Experience
- Use Intel Optimized Libraries & Frameworks
- Leverage Intel Developer Zone Resources

https://github.com/intel-analytics/BigDL

http://software.intel.com/ai



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